

Features

- High Density Cell Desihn for Ultra Low $R_{DS(on)}$
- Fully Characterized Avalanche Voltage and Current
- Good Stability and Uniformity with High E_{AS}
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensivity Level 1
- Halogen Free Available Upon Request By Adding Suffix "-HF"
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

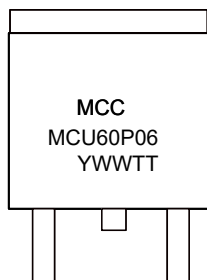
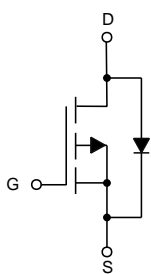
Maximum Ratings

- Operating Junction Temperature Range : -55°C to +175°C
- Storage Temperature Range: -55°C to +175°C
- Thermal Resistance: 0.847°C/W Junction to Case^(Note 1)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	V_{DS}	-60	V	
Gate-Source Voltlage	V_{GS}	±20	V	
Continuous Drain Current	I_D	$T_C=25^\circ C$	-60	A
		$T_C=100^\circ C$	-42.3	A
Pulsed Drain Current	I_{DM}	-260	A	
Single Pulse Avalanche Energy ^(Note 2)	E_{AS}	722	mJ	
Total Power Dissipation	P_D	177	W	

Note: 1.Surface Mounted on FR4 Board, $t \leq 10$ sec.
 2. $T_J=25^\circ C, V_{DD}=-30V, V_G=-10V, L=0.5mH, R_g=25\Omega$.

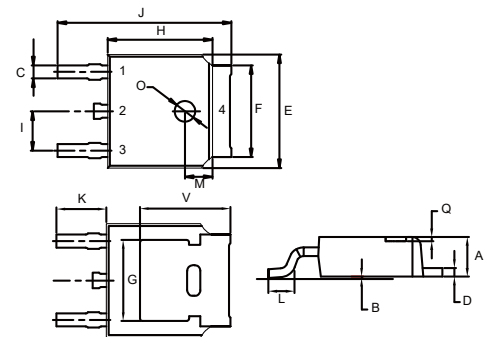
Internal Structure and Marking Code



YWWTT: 5 codes in total
 Y is the year
 WW is the cycle
 TT is the line type

**P-CHANNEL
MOSFET**

DPAK(TO-252)



- 1. Gate
- 2,4. Drain
- 3. Source

DIM	DIMENSIONS				NOTE
	INCHES		MM		
	MIN	MAX	MIN	MAX	
A	0.087	0.094	2.20	2.40	
B	0.000	0.005	0.00	0.13	
C	0.026	0.034	0.66	0.86	
D	0.018	0.023	0.46	0.58	
E	0.256	0.264	6.50	6.70	
F	0.201	0.215	5.10	5.46	
G	0.190		4.83		TYP.
H	0.236	0.244	6.00	6.20	
I	0.086	0.094	2.18	2.39	
J	0.386	0.409	9.80	10.40	
K	0.114		2.90		TYP.
L	0.055	0.067	1.40	1.70	
M	0.063		1.60		TYP.
O	0.043	0.051	1.10	1.30	
Q	0.000	0.012	0.00	0.30	
V	0.211		5.35		TYP.

Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-60			V
Gate-Source Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-60V, V_{GS}=0V$			-1	μA
Gate-Threshold Voltage ^(Note 3)	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-2	-2.6	-3.5	V
Drain-Source On-Resistance ^(Note 3)	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-20A$		13	18	m Ω
Forward Transconductance ^(Note 3)	g_{FS}	$V_{DS}=-5V, I_D=-20A$		25		S
Dynamic Characteristics^(Note 4)						
Input Capacitance	C_{iss}	$V_{DS}=-25V, V_{GS}=0V, f=1MHz$		5814		pF
Output Capacitance	C_{oss}			483		
Reverse Transfer Capacitance	C_{rss}			234		
Total Gate Charge	Q_g	$V_{DS}=-30V, V_{GS}=-10V, I_D=-20A$		75		nC
Gate-Source Charge	Q_{gs}			16		
Gate-Drain Charge	Q_{gd}			19		
Reverse Recovery Charge	Q_{rr}	$I_S=-20A, di/dt=-100A/\mu s$		71		
Reverse Recovery Time	t_{rr}			49		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=-30V, R_L=1.5\Omega, V_{GS}=-10V, R_G=3\Omega$		18		ns
Turn-On Rise Time	t_r			20		
Turn-Off Delay Time	$t_{d(off)}$			55		
Turn-Off Fall Time	t_f			35		
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	$T_C=25^\circ C$			-60	A
Body Diode Voltage	V_{SD}	$I_{SD}=-20A, V_{GS}=0V$			-1.2	V

 Note 3. Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.

4. Guaranteed by Design, Not Subject to Production Testing.

Curve Characteristics

Fig. 1 - Output Characteristics

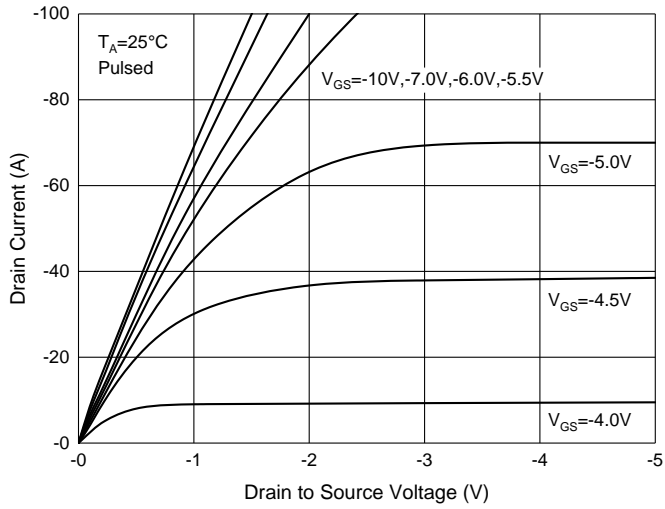


Fig. 2 - Transfer Characteristics

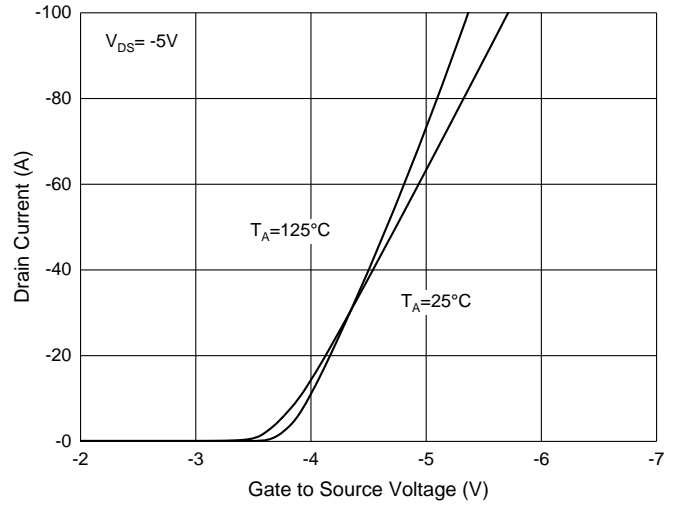


Fig. 3 - $R_{DS(ON)} - I_D$

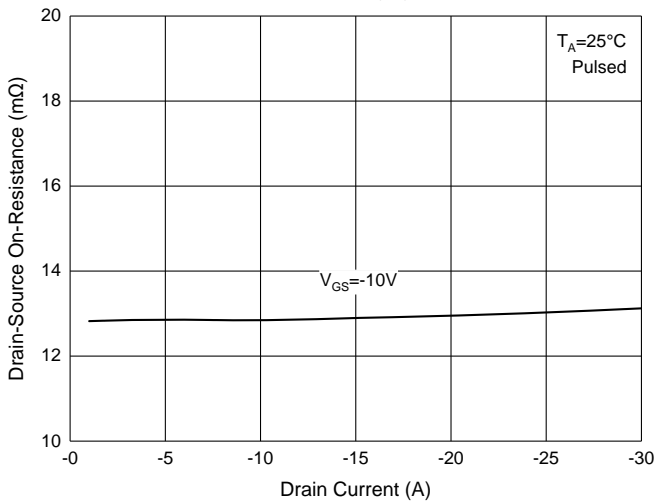


Fig. 4 - $R_{DS(ON)} - \text{Temperature}$

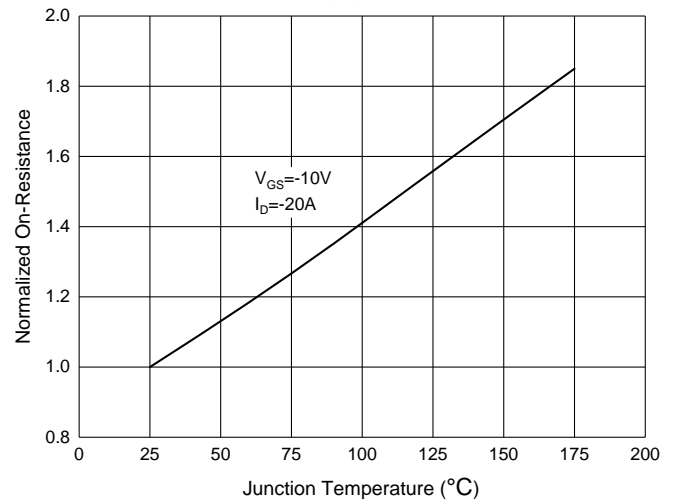


Fig. 5 - Gate Charge

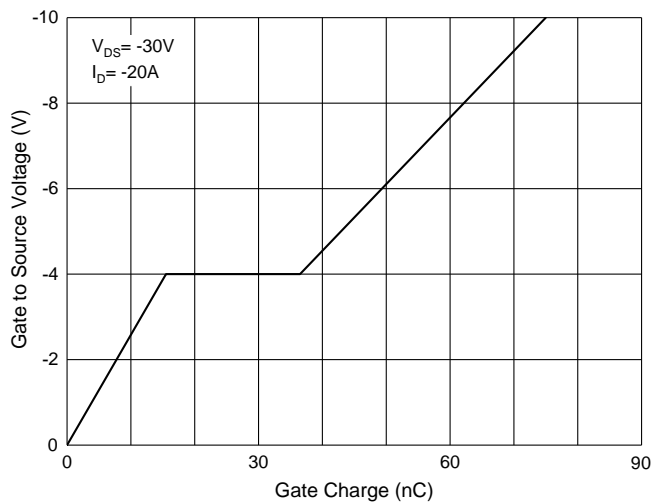
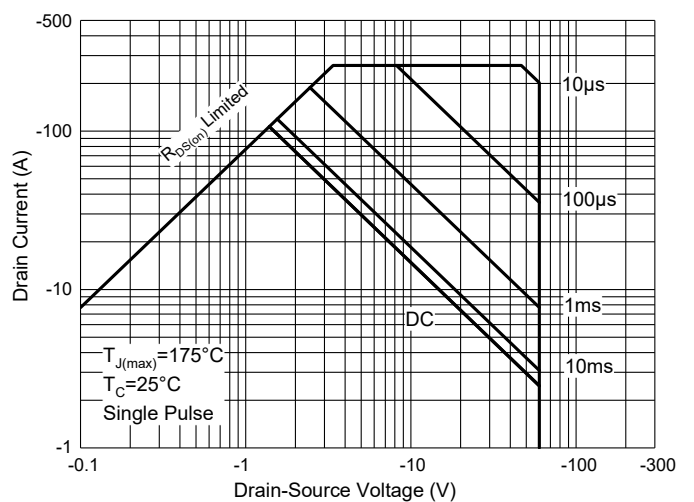
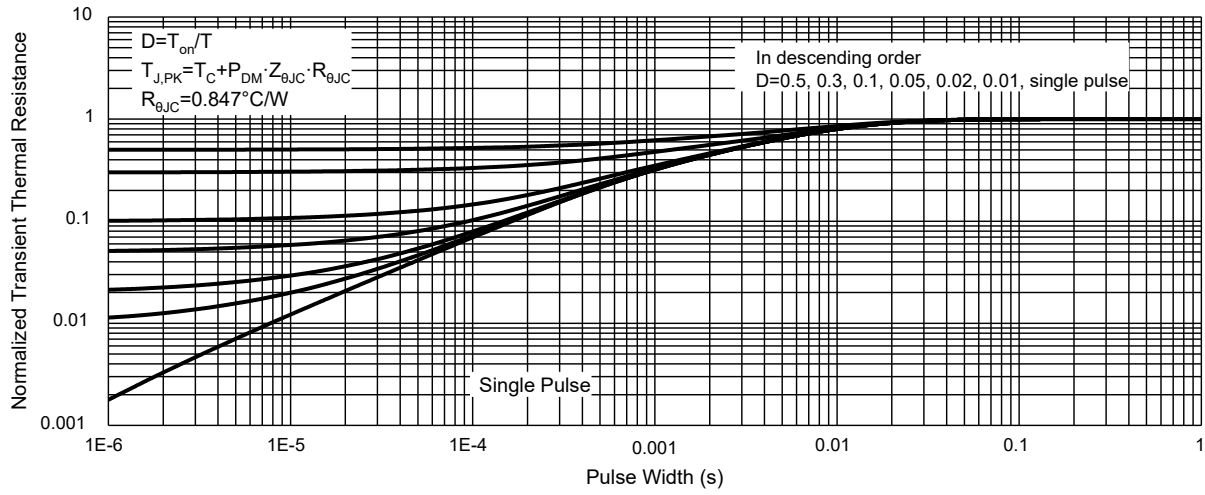


Fig. 6 - Safe Operation Area



Curve Characteristics

Fig. 7 - Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 2.5Kpcs/Reel

Note : Adding "-HF" Suffix for Halogen Free, eg. Part Number-TP-HF

IMPORTANT NOTICE

Micro Commercial Components Corp. reserves the right to make changes without further notice to any product herein to make corrections, modifications , enhancements , improvements , or other changes . **Micro Commercial Components Corp** . does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights ,nor the rights of others . The user of products in such applications shall assume all risks of such use and will agree to hold **Micro Commercial Components Corp** . and all the companies whose products are represented on our website, harmless against all damages. **Micro Commercial Components Corp.** products are sold subject to the general terms and conditions of commercial sale, as published at <https://www.mccsemi.com/Home/TermsAndConditions>.

LIFE SUPPORT

MCC's products are not authorized for use as critical components in life support devices or systems without the express written approval of Micro Commercial Components Corporation.

CUSTOMER AWARENESS

Counterfeiting of semiconductor parts is a growing problem in the industry. Micro Commercial Components (MCC) is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. MCC strongly encourages customers to purchase MCC parts either directly from MCC or from Authorized MCC Distributors who are listed by country on our web page cited below. Products customers buy either from MCC directly or from Authorized MCC Distributors are genuine parts, have full traceability, meet MCC's quality standards for handling and storage. **MCC will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources.** MCC is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

单击下面可查看定价，库存，交付和生命周期等信息

[>>MCC\(美微科\)](#)